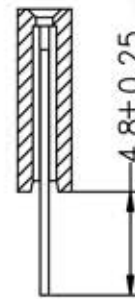


Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



HSF RoHS

SPECIFICATIONS

Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: LCP
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)